

**SUPER FAST
GLASS PASSIVATED RECTIFIER**

**REVERSE VOLTAGE – 200Volts
FORWARD CURRENT – 10 Amperes**

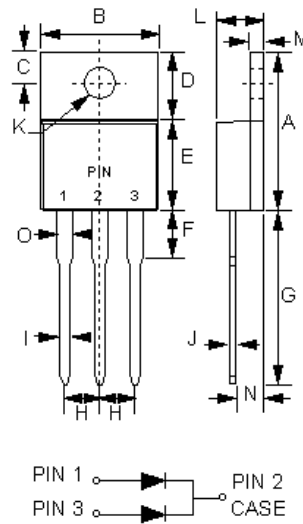
FEATURES

- Glass passivated chip
- Superfast switching time for high efficiency
- Low forward voltage drop and high current capability
- Low reverse leakage current

MECHANICAL DATA

- Case: JEDEC TO-220AB
- Case Material: Plastic material, UL flammability classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Lead Free Plating
- Polarity indicator: As marked on the body
- Weight: 0.08 ounces, 2.24 grams
- Component in accordance to RoHs 2002/95/EC
- ESD capability : HBM_8KV (JESD22-A114)
- Maximum mounting torque = 0.5 N.m (5.1 Kgf.cm)

TO-220AB



TO-220AB		
DIM.	MIN.	MAX.
A	14.40	15.20
B	9.65	10.67
C	2.54	3.43
D	5.84	6.86
E	8.26	9.28
F	-	4.20
G	12.70	14.73
H	2.29	2.79
I	0.51	1.14
J	0.30	0.64
K	3.53 \varnothing	4.09 \varnothing
L	3.56	4.83
M	1.14	1.40
N	2.03	2.92
O	1.14	1.70

All Dimensions in millimeter

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS
Ratings at 25°C ambient temperature unless otherwise specified.

PARAMETER	SYMBOL	STPR1020CTW			UNIT	
Device marking code	Note	STPR1020CTW			---	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200			V	
Average Rectified Output Current See FIG.1	I_F	10			A	
Peak Forward Surge Current 8.3ms single half sine-wave	I_{FSM}	80			A	
Storage temperature range	T_{STG}	-55 to +150			°C	
Operating junction temperature range	T_J	-55 to +150			°C	
PARAMETER	TEST CONDITIONS	SYMBOL	Min.	Typ.	Max.	UNIT
Breakdown voltage	$I_R=10\mu A$ $T_J=25^\circ C$	V_B	200	---	---	V
Forward Voltage (1)	$I_F=5A$ $T_J=25^\circ C$ $T_J=125^\circ C$	V_F	---	0.94	1.10	V
	$I_F=10A$ $T_J=25^\circ C$ $T_J=125^\circ C$		---	0.80	1.00	
			---	1.05	1.25	
Leakage Current	$V_R=200V$ $T_J=25^\circ C$ $T_J=100^\circ C$	I_R	---	0.05	10	μA
Reverse recovery time	$I_F=0.5A$ $I_{rr}=0.25A$ $I_R=1.0A$ $T_J=25^\circ C$	t_{rr}	---	22	30	ns
Junction Capacitance	$V_R=4V$ Freq.=1MHz $T_J=25^\circ C$	C_j	---	30	50	pF
THERMAL CHARACTERISTIC		SYMBOL	Typical			UNIT
Typical thermal resistance, Junction to Ambient (2)		$R_{\theta JA}$	12			°C/W
Typical thermal resistance, Junction to Lead (2)		$R_{\theta JL}$	6.0			°C/W
Typical thermal resistance, Junction to Case (2)		$R_{\theta JC}$	4.2			°C/W

Note :

- (1) 300us Pulse Width, 2% Duty Cycle.
- (2) Thermal Resistance test performed in accordance with JESD-51. $R_{\theta JL}$ is measured at the PIN 2, $R_{\theta JC}$ is measured at the top centre of body.

REV. 7, Sep-2012, KTGA24

FIG.1- FORWARD CURRENT DERATING CURVE

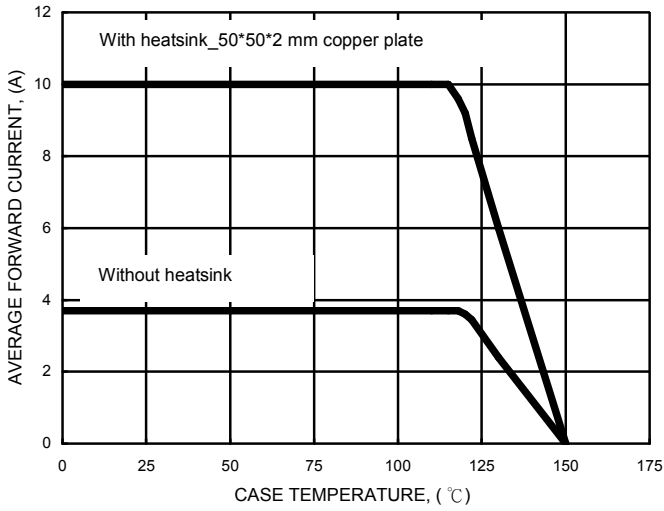


FIG.2- MAXIMUM NON-REPETITIVE SURGE CURRENT

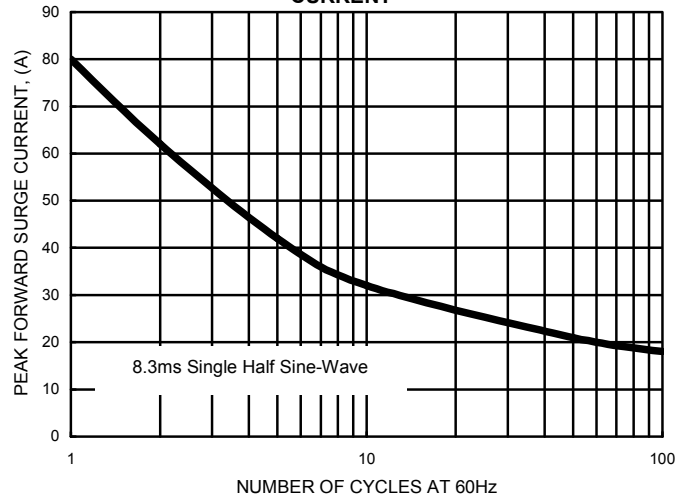


FIG.3- TYPICAL FORWARD CHARACTERISTICS

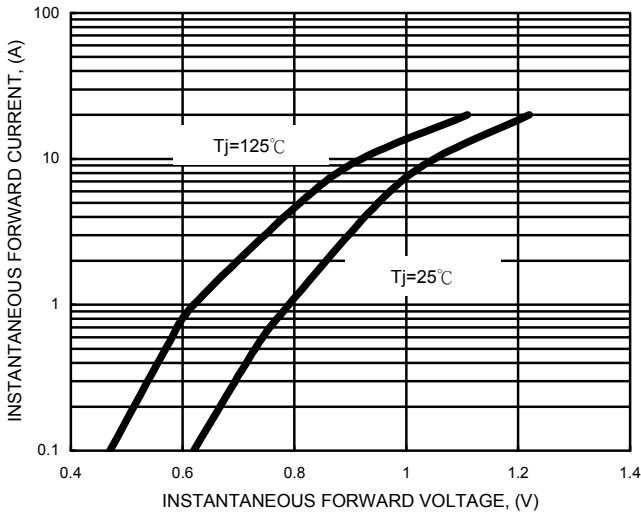


FIG.4- TYPICAL JUNCTION CAPACITANCE

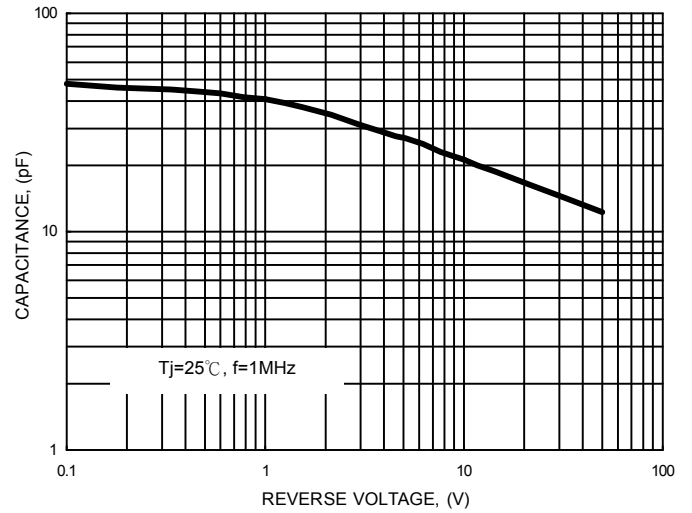
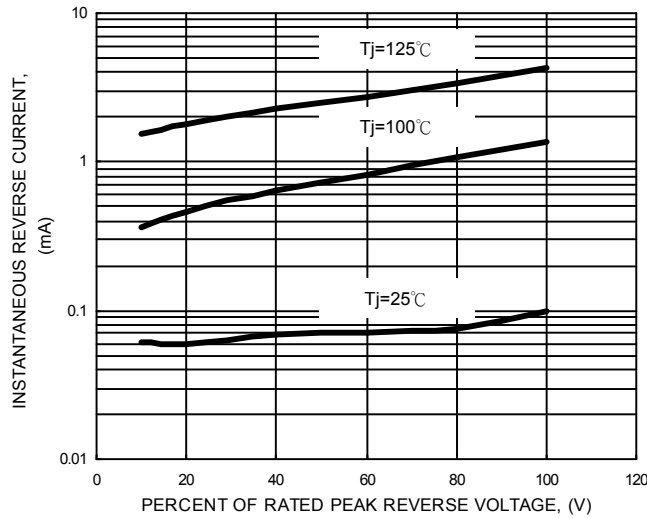


FIG.5- TYPICAL REVERSE CHARACTERISTICS



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